



# HIGH-SPEED 3.3V 16K x 36 SYNCHRONOUS PIPELINED DUAL-PORT STATIC RAM WITH 3.3V OR 2.5V INTERFACE

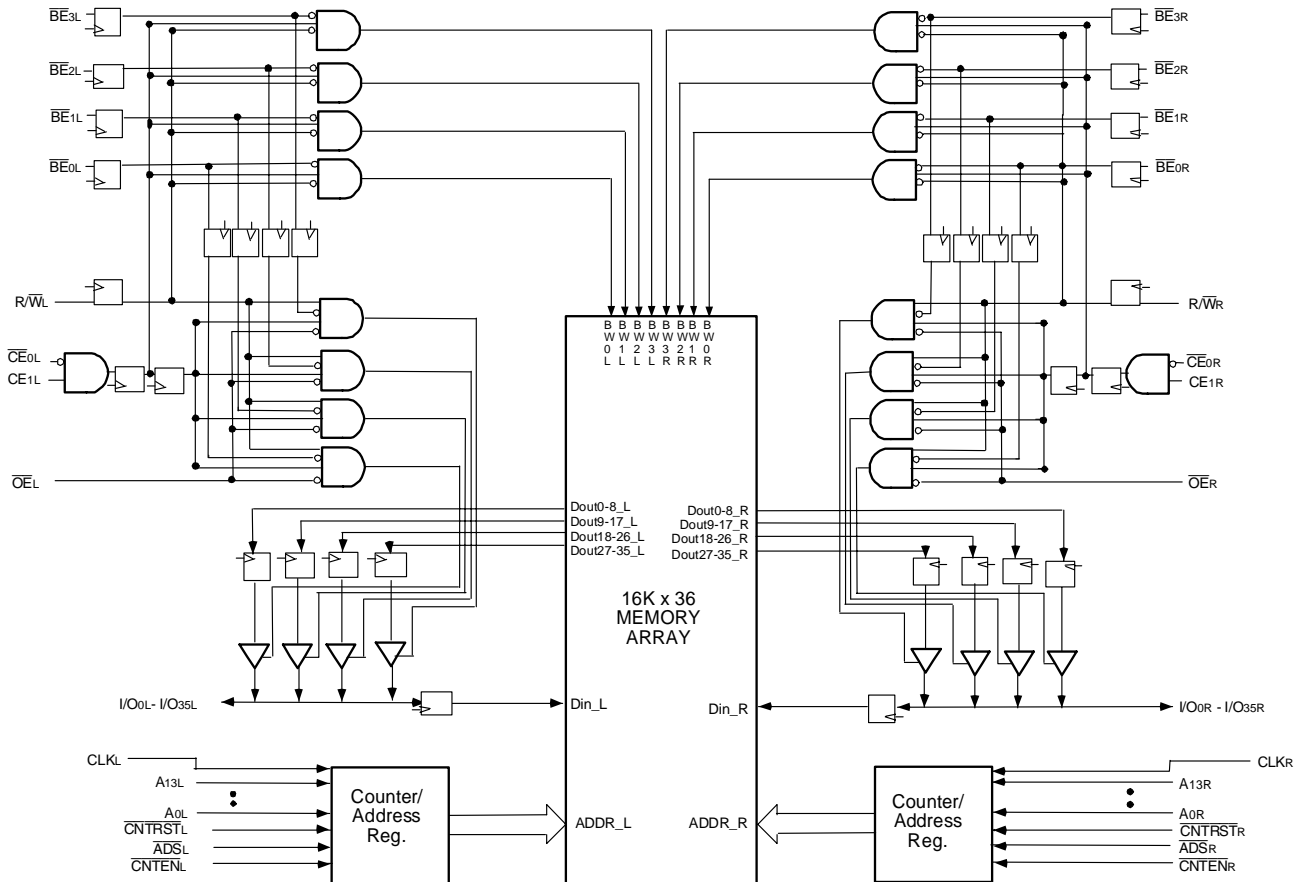
**IDT70V3569S**

## Features:

- ◆ True Dual-Port memory cells which allow simultaneous access of the same memory location
- ◆ High-speed clock to data access
  - Commercial: 4.2/5/6ns (max.)
  - Industrial: 5ns (max)
- ◆ Pipelined output mode
- ◆ Counter enable and reset features
- ◆ Dual chip enables allow for depth expansion without additional logic
- ◆ Full synchronous operation on both ports
  - 7.5ns cycle time, 133MHz operation (9.6 Gbps bandwidth)
  - Fast 4.2ns clock to data out
  - 1.8ns setup to clock and 0.7ns hold on all control, data, and address inputs @ 133MHz

- Data input, address, byte enable and control registers
- Self-timed write allows fast cycle time
- ◆ Separate byte controls for multiplexed bus and bus matching compatibility
- ◆ LVTTTL-compatible, single 3.3V (±150mV) power supply for core
- ◆ LVTTTL-compatible, selectable 3.3V (±150mV)/2.5V (±125mV) power supply for I/Os and control signals on each port
- ◆ Industrial temperature range (-40°C to +85°C) is available for selected speeds
- ◆ Available in a 208-pin Plastic Quad Flatpack (PQFP), 208-ball fine-pitch Ball Grid Array, and 256-pin Ball Grid Array
- ◆ Green parts available, see ordering instructions

## Functional Block Diagram



4831 tbl 01

**OCTOBER 2008**

### Description:

The IDT70V3569 is a high-speed 16Kx36 bit synchronous Dual-Port RAM. The memory array utilizes Dual-Port memory cells to allow simultaneous access of any address from both ports. Registers on control, data, and address inputs provide minimal setup and hold times. The timing latitude provided by this approach allows systems to be designed with very short cycle times. With an input data register, the IDT70V3569 has been optimized for applications having unidirectional or bidirectional data flow

in bursts. An automatic power down feature, controlled by  $\overline{CE}_0$  and  $CE_1$ , permits the on-chip circuitry of each port to enter a very low standby power mode.

The 70V3569 can support an operating voltage of either 3.3V or 2.5V on one or both ports, controllable by the OPT pins. The power supply for the core of the device (VDD) remains at 3.3V.

### Pin Configuration(1,2,3,4)

12/12/01

A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12	A13	A14	A15	A16	A17	<b>70V3569BF</b> <b>BF-208<sup>(5)</sup></b>  <b>208-Pin fpBGA</b> <b>Top View<sup>(6)</sup></b>										
IO19L	IO18L	VSS	NC	NC	NC	A12L	A8L	$\overline{BE}_{1L}$	VDD	CLKL	$\overline{CNTEN}_L$	A4L	A0L	OPTL	I/O17L	VSS											
B1	B2	B3	B4	B5	B6	B7	B8	B9	B10	B11	B12	B13	B14	B15	B16	B17											
I/O20R	VSS	I/O18R	VSS	NC	A13L	A9L	$\overline{BE}_{2L}$	$\overline{CE}_{0L}$	VSS	$\overline{ADSL}$	A5L	A1L	VSS	VDDQR	I/O16L	I/O15R											
C1	C2	C3	C4	C5	C6	C7	C8	C9	C10	C11	C12	C13	C14	C15	C16	C17											
VDDQL	I/O19R	VDDQR	VDD	NC	NC	A10L	$\overline{BE}_{3L}$	$\overline{CE}_{1L}$	VSS	R/WL	A6L	A2L	VDD	I/O16R	I/O15L	VSS											
D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14	D15	D16	D17											
I/O22L	VSS	I/O21L	I/O20L	NC	A11L	A7L	$\overline{BE}_{0L}$	VDD	$\overline{OE}_L$	$\overline{CNTRST}_L$	A3L	VDD	I/O17R	VDDQL	I/O14L	I/O14R											
E1	E2	E3	E4											E14	E15	E16											E17
I/O23L	I/O22R	VDDQR	I/O21R											I/O12L	I/O13R	VSS											I/O13L
F1	F2	F3	F4											F14	F15	F16											F17
VDDQL	I/O23R	I/O24L	VSS											VSS	I/O12R	I/O11L											VDDQR
G1	G2	G3	G4											G14	G15	G16											G17
I/O26L	VSS	I/O25L	I/O24R											I/O9L	VDDQL	I/O10L											I/O11R
H1	H2	H3	H4											H14	H15	H16											H17
VDD	I/O26R	VDDQR	I/O25R											VDD	I/O9R	VSS											I/O10R
J1	J2	J3	J4											J14	J15	J16											J17
VDDQL	VDD	VSS	VSS											VSS	VDD	VSS											VDDQR
K1	K2	K3	K4											K14	K15	K16											K17
I/O28R	VSS	I/O27R	VSS											I/O7R	VDDQL	I/O8R											VSS
L1	L2	L3	L4											L14	L15	L16	L17										
I/O29R	I/O28L	VDDQR	I/O27L											I/O6R	I/O7L	VSS	I/O8L										
M1	M2	M3	M4											M14	M15	M16	M17										
VDDQL	I/O29L	I/O30R	VSS											VSS	I/O6L	I/O5R	VDDQR										
N1	N2	N3	N4											N14	N15	N16	N17										
I/O31L	VSS	I/O31R	I/O30L											I/O3R	VDDQL	I/O4R	I/O5L										
P1	P2	P3	P4	P5	P6	P7	P8	P9	P10	P11	P12	P13	P14	P15	P16	P17											
I/O32R	I/O32L	VDDQR	I/O35R	NC	NC	A12R	A8R	$\overline{BE}_{1R}$	VDD	CLKR	$\overline{CNTEN}_R$	A4R	I/O2L	I/O3L	VSS	I/O4L											
R1	R2	R3	R4	R5	R6	R7	R8	R9	R10	R11	R12	R13	R14	R15	R16	R17											
VSS	I/O33L	I/O34R	NC	NC	A13R	A9R	$\overline{BE}_{2R}$	$\overline{CE}_{0R}$	VSS	$\overline{ADSR}$	A5R	A1R	VSS	VDDQL	I/O1R	VDDQR											
T1	T2	T3	T4	T5	T6	T7	T8	T9	T10	T11	T12	T13	T14	T15	T16	T17											
I/O33R	I/O34L	VDDQL	VSS	NC	NC	A10R	$\overline{BE}_{3R}$	$\overline{CE}_{1R}$	VSS	R/WR	A6R	A2R	VSS	I/O0R	VSS	I/O2R											
U1	U2	U3	U4	U5	U6	U7	U8	U9	U10	U11	U12	U13	U14	U15	U16	U17											
VSS	I/O35L	VDD	NC	NC	A11R	A7R	$\overline{BE}_{0R}$	VDD	$\overline{OE}_R$	$\overline{CNTRST}_R$	A3R	A0R	VDD	OPTR	I/O0L	I/O1L											

**NOTES:**

1. All VDD pins must be connected to 3.3V power supply.
2. All VDDQ pins must be connected to appropriate power supply: 3.3V if OPT pin for that port is set to VIH (3.3V), and 2.5V if OPT pin for that port is set to VIL (0V).
3. All VSS pins must be connected to ground supply.
4. Package body is approximately 15mm x 15mm x 1.4mm, with 0.8mm ball pitch.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part-marking.

4831 drw 02c

## Pin Configuration<sup>(1,2,3,4)</sup> (con't.)

70V3569BC  
BC-256<sup>(5)</sup>

256-Pin BGA  
Top View<sup>(6)</sup>

12/12/01

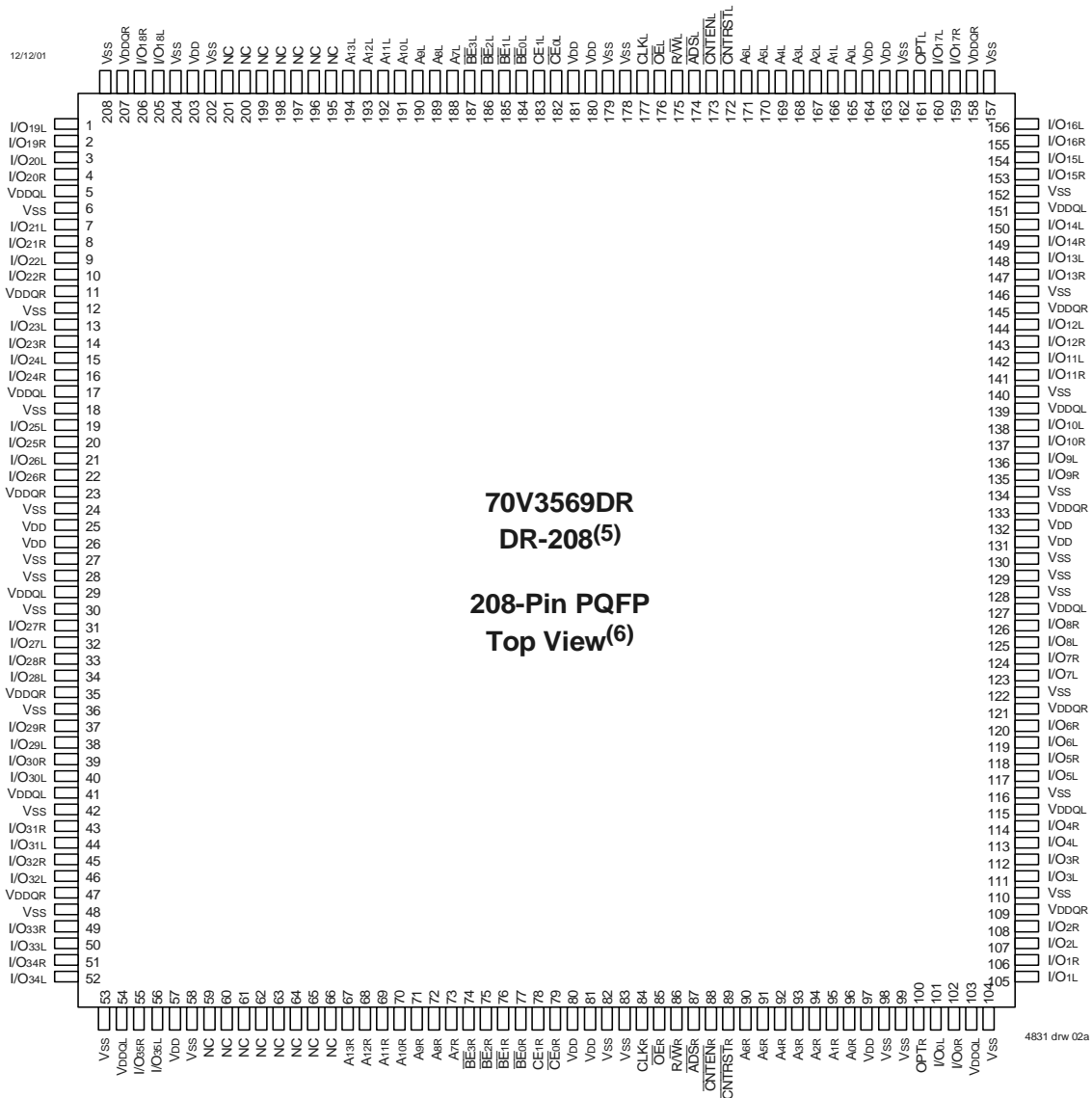
A1 NC	A2 NC	A3 NC	A4 NC	A5 NC	A6 A11L	A7 A8L	A8 $\overline{BE}_{2L}$	A9 $\overline{CE}_{1L}$	A10 $\overline{OE}_{L}$	A11 $\overline{CNTEN}_{L}$	A12 A5L	A13 A2L	A14 A0L	A15 NC	A16 NC
B1 I/O18L	B2 NC	B3 NC	B4 NC	B5 NC	B6 A12L	B7 A9L	B8 $\overline{BE}_{3L}$	B9 $\overline{CE}_{0L}$	B10 R/W $\overline{L}$	B11 $\overline{CNTRST}_{L}$	B12 A4L	B13 A1L	B14 VDD	B15 I/O17L	B16 NC
C1 I/O18R	C2 I/O19L	C3 VSS	C4 NC	C5 A13L	C6 A10L	C7 A7L	C8 $\overline{BE}_{1L}$	C9 $\overline{BE}_{0L}$	C10 CLKL	C11 $\overline{AD}_{S}_{L}$	C12 A6L	C13 A3L	C14 OPTL	C15 I/O17R	C16 I/O16L
D1 I/O20R	D2 I/O19R	D3 I/O20L	D4 VDD	D5 VDDQL	D6 VDDQL	D7 VDDQR	D8 VDDQR	D9 VDDQL	D10 VDDQL	D11 VDDQR	D12 VDDQR	D13 VDD	D14 I/O15R	D15 I/O15L	D16 I/O16R
E1 I/O21R	E2 I/O21L	E3 I/O22L	E4 VDDQL	E5 VDD	E6 VDD	E7 VSS	E8 VSS	E9 VSS	E10 VSS	E11 VDD	E12 VDD	E13 VDDQR	E14 I/O13L	E15 I/O14L	E16 I/O14R
F1 I/O23L	F2 I/O22R	F3 I/O23R	F4 VDDQL	F5 VDD	F6 VSS	F7 VSS	F8 VSS	F9 VSS	F10 VSS	F11 VSS	F12 VDD	F13 VDDQR	F14 I/O12R	F15 I/O13R	F16 I/O12L
G1 I/O24R	G2 I/O24L	G3 I/O25L	G4 VDDQR	G5 VSS	G6 VSS	G7 VSS	G8 VSS	G9 VSS	G10 VSS	G11 VSS	G12 VSS	G13 VDDQL	G14 I/O10L	G15 I/O11L	G16 I/O11R
H1 I/O26L	H2 I/O25R	H3 I/O26R	H4 VDDQR	H5 VSS	H6 VSS	H7 VSS	H8 VSS	H9 VSS	H10 VSS	H11 VSS	H12 VSS	H13 VDDQL	H14 I/O9R	H15 I/O9L	H16 I/O10R
J1 I/O27L	J2 I/O28R	J3 I/O27R	J4 VDDQL	J5 VSS	J6 VSS	J7 VSS	J8 VSS	J9 VSS	J10 VSS	J11 VSS	J12 VSS	J13 VDDQR	J14 I/O8R	J15 I/O7R	J16 I/O8L
K1 I/O29R	K2 I/O29L	K3 I/O28L	K4 VDDQL	K5 VSS	K6 VSS	K7 VSS	K8 VSS	K9 VSS	K10 VSS	K11 VSS	K12 VSS	K13 VDDQR	K14 I/O6R	K15 I/O6L	K16 I/O7L
L1 I/O30L	L2 I/O31R	L3 I/O30R	L4 VDDQR	L5 VDD	L6 VSS	L7 VSS	L8 VSS	L9 VSS	L10 VSS	L11 VSS	L12 VDD	L13 VDDQL	L14 I/O5L	L15 I/O4R	L16 I/O5R
M1 I/O32R	M2 I/O32L	M3 I/O31L	M4 VDDQR	M5 VDD	M6 VDD	M7 VSS	M8 VSS	M9 VSS	M10 VSS	M11 VDD	M12 VDD	M13 VDDQL	M14 I/O3R	M15 I/O3L	M16 I/O4L
N1 I/O33L	N2 I/O34R	N3 I/O33R	N4 VDD	N5 VDDQR	N6 VDDQR	N7 VDDQL	N8 VDDQL	N9 VDDQR	N10 VDDQR	N11 VDDQL	N12 VDDQL	N13 VDD	N14 I/O2L	N15 I/O1R	N16 I/O2R
P1 I/O35R	P2 I/O34L	P3 NC	P4 NC	P5 A13R	P6 A10R	P7 A7R	P8 $\overline{BE}_{1R}$	P9 $\overline{BE}_{0R}$	P10 CLKR	P11 $\overline{AD}_{S}_{R}$	P12 A6R	P13 A3R	P14 I/O0L	P15 I/O0R	P16 I/O1L
R1 I/O35L	R2 NC	R3 NC	R4 NC	R5 NC	R6 A12R	R7 A9R	R8 $\overline{BE}_{3R}$	R9 $\overline{CE}_{0R}$	R10 R/W $\overline{R}$	R11 $\overline{CNTRST}_{R}$	R12 A4R	R13 A1R	R14 OPTR	R15 NC	R16 NC
T1 NC	T2 NC	T3 NC	T4 NC	T5 NC	T6 A11R	T7 A8R	T8 $\overline{BE}_{2R}$	T9 $\overline{CE}_{1R}$	T10 $\overline{OE}_{R}$	T11 $\overline{CNTEN}_{R}$	T12 A5R	T13 A2R	T14 A0R	T15 NC	T16 NC

4831 drw 02d

### NOTES:

1. All VDD pins must be connected to 3.3V power supply.
2. All VDDQ pins must be connected to appropriate power supply: 3.3V if OPT pin for that port is set to VIH (3.3V), and 2.5V if OPT pin for that port is set to VIL (0V).
3. All VSS pins must be connected to ground supply.
4. Package body is approximately 17mm x 17mm x 1.4mm, with 1.0mm ball-pitch.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part-marking.

Pin Configuration<sup>(1,2,3,4)</sup> (con't.)



**NOTES:**

1. All V<sub>DD</sub> pins must be connected to 3.3V power supply.
2. All V<sub>DDQ</sub> pins must be connected to appropriate power supply: 3.3V if OPT pin for that port is set to V<sub>IH</sub> (3.3V), and 2.5V if OPT pin for that port is set to V<sub>IL</sub> (0V).
3. All V<sub>SS</sub> pins must be connected to ground supply.
4. Package body is approximately 28mm x 28mm x 3.5mm.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part-marking.

## Pin Names

Left Port	Right Port	Names
$\overline{CE}_{0L}$ , $CE_{1L}$	$\overline{CE}_{0R}$ , $CE_{1R}$	Chip Enables
$R/\overline{W}_L$	$R/\overline{W}_R$	Read/Write Enable
$\overline{OE}_L$	$\overline{OE}_R$	Output Enable
$A_{0L}$ - $A_{13L}$	$A_{0R}$ - $A_{13R}$	Address
$I/O_{0L}$ - $I/O_{35L}$	$I/O_{0R}$ - $I/O_{35R}$	Data Input/Output
$CLK_L$	$CLK_R$	Clock
$\overline{ADS}_L$	$\overline{ADS}_R$	Address Strobe Enable
$\overline{CNTEN}_L$	$\overline{CNTEN}_R$	Counter Enable
$\overline{CNTRST}_L$	$\overline{CNTRST}_R$	Counter Reset
$\overline{BE}_{0L}$ - $\overline{BE}_{3L}$	$\overline{BE}_{0R}$ - $\overline{BE}_{3R}$	Byte Enables (9-bit bytes)
$V_{DDQL}$	$V_{DDQR}$	Power (I/O Bus) (3.3V or 2.5V) <sup>(1)</sup>
$OPT_L$	$OPT_R$	Option for selection $V_{DDQX}$ <sup>(1,2)</sup>
$V_{DD}$		Power (3.3V) <sup>(1)</sup>
$V_{SS}$		Ground (0V)

4831 tbl 01

### NOTES:

- $V_{DD}$ ,  $OPT_X$ , and  $V_{DDQX}$  must be set to appropriate operating levels prior to applying inputs on the I/Os and controls for that port.
- $OPT_X$  selects the operating voltage levels for the I/Os and controls on that port. If  $OPT_X$  is set to  $V_{IH}$  (3.3V), then that port's I/Os and controls will operate at 3.3V levels and  $V_{DDQX}$  must be supplied at 3.3V. If  $OPT_X$  is set to  $V_{IL}$  (0V), then that port's I/Os and controls will operate at 2.5V levels and  $V_{DDQX}$  must be supplied at 2.5V. The  $OPT$  pins are independent of one another—both ports can operate at 3.3V levels, both can operate at 2.5V levels, or either can operate at 3.3V with the other at 2.5V.

## Truth Table I—Read/Write and Enable Control<sup>(1,2,3,4)</sup>

OE	CLK	$\overline{CE}_0$	CE <sub>1</sub>	$\overline{BE}_3$	$\overline{BE}_2$	$\overline{BE}_1$	$\overline{BE}_0$	R/ $\overline{W}$	Byte 3 I/O <sub>27-35</sub>	Byte 2 I/O <sub>18-26</sub>	Byte 1 I/O <sub>9-17</sub>	Byte 0 I/O <sub>0-8</sub>	MODE
X	↑	H	X	X	X	X	X	X	High-Z	High-Z	High-Z	High-Z	Deselected—Power Down
X	↑	X	L	X	X	X	X	X	High-Z	High-Z	High-Z	High-Z	Deselected—Power Down
X	↑	L	H	H	H	H	H	X	High-Z	High-Z	High-Z	High-Z	All Bytes Deselected
X	↑	L	H	H	H	H	L	L	High-Z	High-Z	High-Z	D <sub>IN</sub>	Write to Byte 0 Only
X	↑	L	H	H	H	L	H	L	High-Z	High-Z	D <sub>IN</sub>	High-Z	Write to Byte 1 Only
X	↑	L	H	H	L	H	H	L	High-Z	D <sub>IN</sub>	High-Z	High-Z	Write to Byte 2 Only
X	↑	L	H	L	H	H	H	L	D <sub>IN</sub>	High-Z	High-Z	High-Z	Write to Byte 3 Only
X	↑	L	H	H	H	L	L	L	High-Z	High-Z	D <sub>IN</sub>	D <sub>IN</sub>	Write to Lower 2 Bytes Only
X	↑	L	H	L	L	H	H	L	D <sub>IN</sub>	D <sub>IN</sub>	High-Z	High-Z	Write to Upper 2 bytes Only
X	↑	L	H	L	L	L	L	L	D <sub>IN</sub>	D <sub>IN</sub>	D <sub>IN</sub>	D <sub>IN</sub>	Write to All Bytes
L	↑	L	H	H	H	H	L	H	High-Z	High-Z	High-Z	D <sub>OUT</sub>	Read Byte 0 Only
L	↑	L	H	H	H	L	H	H	High-Z	High-Z	D <sub>OUT</sub>	High-Z	Read Byte 1 Only
L	↑	L	H	H	L	H	H	H	High-Z	D <sub>OUT</sub>	High-Z	High-Z	Read Byte 2 Only
L	↑	L	H	L	H	H	H	H	D <sub>OUT</sub>	High-Z	High-Z	High-Z	Read Byte 3 Only
L	↑	L	H	H	H	L	L	H	High-Z	High-Z	D <sub>OUT</sub>	D <sub>OUT</sub>	Read Lower 2 Bytes Only
L	↑	L	H	L	L	H	H	H	D <sub>OUT</sub>	D <sub>OUT</sub>	High-Z	High-Z	Read Upper 2 Bytes Only
L	↑	L	H	L	L	L	L	H	D <sub>OUT</sub>	D <sub>OUT</sub>	D <sub>OUT</sub>	D <sub>OUT</sub>	Read All Bytes
H	↑	L	H	L	L	L	L	X	High-Z	High-Z	High-Z	High-Z	Outputs Disabled

### NOTES:

- "H" =  $V_{IH}$ , "L" =  $V_{IL}$ , "X" = Don't Care.
- $\overline{ADS}$ ,  $\overline{CNTEN}$ ,  $\overline{CNTRST}$  = X.
- OE is an asynchronous input signal.
- It is possible to read or write any combination of bytes during a given access. A few representative samples have been illustrated here.

4831 tbl 02

Truth Table II—Address Counter Control<sup>(1,2)</sup>

Address	Previous Address	Addr Used	CLK <sup>(6)</sup>	$\overline{\text{ADS}}$	$\overline{\text{CNTEN}}$	$\overline{\text{CNRST}}$	I/O <sup>(3)</sup>	MODE
X	X	0	↑	X	X	L <sup>(4)</sup>	D <sub>IO</sub> (0)	Counter Reset to Address 0
An	X	An	↑	L <sup>(4)</sup>	X	H	D <sub>IO</sub> (n)	External Address Used
An	Ap	Ap	↑	H	H	H	D <sub>IO</sub> (p)	External Address Blocked—Counter disabled (Ap reused)
X	Ap	Ap + 1	↑	H	L <sup>(5)</sup>	H	D <sub>IO</sub> (p+1)	Counter Enabled—Internal Address generation

4831 tbl 03

## NOTES:

- "H" = V<sub>IH</sub>, "L" = V<sub>IL</sub>, "X" = Don't Care.
- Read and write operations are controlled by the appropriate setting of R $\overline{\text{W}}$ ,  $\overline{\text{CE}}_0$ , CE<sub>1</sub>,  $\overline{\text{B}}\overline{\text{E}}_n$  and  $\overline{\text{O}}\overline{\text{E}}$ .
- Outputs are in Pipelined mode: the data out will be delayed by one cycle.
- $\overline{\text{ADS}}$  and  $\overline{\text{CNRST}}$  are independent of all other memory control signals including  $\overline{\text{CE}}_0$ , CE<sub>1</sub> and  $\overline{\text{B}}\overline{\text{E}}_n$ .
- The address counter advances if  $\overline{\text{CNTEN}} = \text{V}_{\text{IL}}$  on the rising edge of CLK, regardless of all other memory control signals including  $\overline{\text{CE}}_0$ , CE<sub>1</sub>,  $\overline{\text{B}}\overline{\text{E}}_n$ .

Recommended Operating Temperature and Supply Voltage<sup>(1)</sup>

Grade	Ambient Temperature	GND	V <sub>DD</sub>
Commercial	0°C to +70°C	0V	3.3V ± 150mV
Industrial	-40°C to +85°C	0V	3.3V ± 150mV

4831 tbl 04

## NOTES:

- Industrial temperature: for specific speeds, packages and powers contact your sales office.

Recommended DC Operating Conditions with V<sub>DDQ</sub> at 2.5V

Symbol	Parameter	Min.	Typ.	Max.	Unit
V <sub>DD</sub>	Core Supply Voltage	3.15	3.3	3.45	V
V <sub>DDQ</sub>	I/O Supply Voltage <sup>(3)</sup>	2.375	2.5	2.625	V
V <sub>SS</sub>	Ground	0	0	0	V
V <sub>IH</sub>	Input High Voltage <sup>(3)</sup> (Address & Control Inputs)	1.7	—	V <sub>DDQ</sub> + 125mV <sup>(2)</sup>	V
V <sub>IH</sub>	Input High Voltage - I/O <sup>(3)</sup>	1.7	—	V <sub>DDQ</sub> + 125mV <sup>(2)</sup>	V
V <sub>IL</sub>	Input Low Voltage	-0.3 <sup>(1)</sup>	—	0.7	V

4831 tbl 05a

## NOTES:

- V<sub>IL</sub> ≥ -1.5V for pulse width less than 10 ns.
- V<sub>TERM</sub> must not exceed V<sub>DDQ</sub> + 125mV.
- To select operation at 2.5V levels on the I/Os and controls of a given port, the OPT pin for that port must be set to V<sub>IL</sub> (0V), and V<sub>DDQx</sub> for that port must be supplied as indicated above.

Absolute Maximum Ratings<sup>(1)</sup>

Symbol	Rating	Commercial & Industrial	Unit
V <sub>TERM</sub> <sup>(2)</sup>	Terminal Voltage with Respect to GND	-0.5 to +4.6	V
T <sub>BIAS</sub>	Temperature Under Bias	-55 to +125	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
I <sub>OUT</sub>	DC Output Current	50	mA

4831 tbl 05

## NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- V<sub>TERM</sub> must not exceed V<sub>DD</sub> + 150mV for more than 25% of the cycle time or 4ns maximum, and is limited to ≤ 20mA for the period of V<sub>TERM</sub> ≥ V<sub>DD</sub> + 150mV.

Recommended DC Operating Conditions with V<sub>DDQ</sub> at 3.3V

Symbol	Parameter	Min.	Typ.	Max.	Unit
V <sub>DD</sub>	Core Supply Voltage	3.15	3.3	3.45	V
V <sub>DDQ</sub>	I/O Supply Voltage <sup>(3)</sup>	3.15	3.3	3.45	V
V <sub>SS</sub>	Ground	0	0	0	V
V <sub>IH</sub>	Input High Voltage (Address & Control Inputs) <sup>(3)</sup>	2.0	—	V <sub>DDQ</sub> + 150mV <sup>(2)</sup>	V
V <sub>IH</sub>	Input High Voltage - I/O <sup>(3)</sup>	2.0	—	V <sub>DDQ</sub> + 150mV <sup>(2)</sup>	V
V <sub>IL</sub>	Input Low Voltage	-0.3 <sup>(1)</sup>	—	0.8	V

4831 tbl 05b

## NOTES:

- V<sub>IL</sub> ≥ -1.5V for pulse width less than 10 ns.
- V<sub>TERM</sub> must not exceed V<sub>DDQ</sub> + 150mV.
- To select operation at 3.3V levels on the I/Os and controls of a given port, the OPT pin for that port must be set to V<sub>IH</sub> (3.3V), and V<sub>DDQx</sub> for that port must be supplied as indicated above.

## Capacitance<sup>(1)</sup>

( $T_A = +25^\circ\text{C}$ ,  $F = 1.0\text{MHz}$ ) PQFP ONLY

Symbol	Parameter	Conditions <sup>(2)</sup>	Max.	Unit
$C_{IN}$	Input Capacitance	$V_{IN} = 3\text{dV}$	8	pF
$C_{OUT}^{(3)}$	Output Capacitance	$V_{OUT} = 3\text{dV}$	10.5	pF

4831 tbl 07

### NOTES:

- These parameters are determined by device characterization, but are not production tested.
- 3dV references the interpolated capacitance when the input and output switch from 0V to 3V or from 3V to 0V.
- $C_{OUT}$  also references  $C_{IO}$ .

## DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range ( $V_{DD} = 3.3\text{V} \pm 150\text{mV}$ )

Symbol	Parameter	Test Conditions	70V3569S		Unit
			Min.	Max.	
$I_{LIL}$	Input Leakage Current <sup>(1)</sup>	$V_{DDQ} = \text{Max.}, V_{IN} = 0\text{V to } V_{DDQ}$	—	10	$\mu\text{A}$
$I_{LOI}$	Output Leakage Current	$\overline{CE}_0 = V_{IH}$ or $CE_1 = V_{IL}, V_{OUT} = 0\text{V to } V_{DDQ}$	—	10	$\mu\text{A}$
$V_{OL} (3.3\text{V})$	Output Low Voltage <sup>(2)</sup>	$I_{OL} = +4\text{mA}, V_{DDQ} = \text{Min.}$	—	0.4	V
$V_{OH} (3.3\text{V})$	Output High Voltage <sup>(2)</sup>	$I_{OH} = -4\text{mA}, V_{DDQ} = \text{Min.}$	2.4	—	V
$V_{OL} (2.5\text{V})$	Output Low Voltage <sup>(2)</sup>	$I_{OL} = +2\text{mA}, V_{DDQ} = \text{Min.}$	—	0.4	V
$V_{OH} (2.5\text{V})$	Output High Voltage <sup>(2)</sup>	$I_{OH} = -2\text{mA}, V_{DDQ} = \text{Min.}$	2.0	—	V

4831 tbl 08

### NOTE:

- At  $V_{DD} \leq -2.0\text{V}$  input leakages are undefined.
- $V_{DDQ}$  is selectable (3.3V/2.5V) via OPT pins. Refer to p.4 for details.

## DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range<sup>(3)</sup> ( $V_{DD} = 3.3V \pm 150mV$ )

Symbol	Parameter	Test Condition	Version	70V3569S4 Com'l Only		70V3569S5 Com'l & Ind		70V3569S6 Com'l Only		Unit
				Typ. <sup>(4)</sup>	Max.	Typ. <sup>(4)</sup>	Max.	Typ. <sup>(4)</sup>	Max.	
IDD	Dynamic Operating Current (Both Ports Active)	$\overline{CE}_L$ and $\overline{CE}_R = V_{IL}$ , Outputs Disabled, $f = f_{MAX}^{(1)}$	COM'L S	375	460	285	360	245	310	mA
			IND S	—	—	285	415	245	360	
ISB1	Standby Current (Both Ports - TTL Level Inputs)	$\overline{CE}_L = \overline{CE}_R = V_{IH}$ $f = f_{MAX}^{(1)}$	COM'L S	145	190	105	145	95	125	mA
			IND S	—	—	105	175	95	150	
ISB2	Standby Current (One Port - TTL Level Inputs)	$\overline{CE}^*A^* = V_{IL}$ and $\overline{CE}^*B^* = V_{IH}^{(5)}$ Active Port Outputs Disabled, $f = f_{MAX}^{(1)}$	COM'L S	265	325	190	260	175	225	mA
			IND S	—	—	190	300	175	260	
ISB3	Full Standby Current (Both Ports - CMOS Level Inputs)	Both Ports $\overline{CE}_L$ and $\overline{CE}_R \geq V_{DDQ} - 0.2V$ , $V_{IN} \geq V_{DDQ} - 0.2V$ or $V_{IN} \leq 0.2V$ , $f = 0^{(2)}$	COM'L S	6	15	6	15	6	15	mA
			IND S	—	—	6	30	6	30	
ISB4	Full Standby Current (One Port - CMOS Level Inputs)	$\overline{CE}^*A^* \leq 0.2V$ and $\overline{CE}^*B^* \geq V_{DDQ} - 0.2V^{(5)}$ $V_{IN} \geq V_{DDQ} - 0.2V$ or $V_{IN} \leq 0.2V$ , Active Port, Outputs Disabled, $f = f_{MAX}^{(1)}$	COM'L S	265	325	180	260	170	225	mA
			IND S	—	—	180	300	170	260	

4831 tbl 09

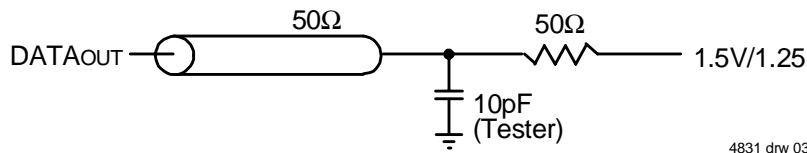
**NOTES:**

- At  $f = f_{MAX}$ , address and control lines (except Output Enable) are cycling at the maximum frequency clock cycle of  $1/t_{cvc}$ , using "AC TEST CONDITIONS" at input levels of GND to 3V.
- $f = 0$  means no address, clock, or control lines change. Applies only to input at CMOS level standby.
- Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- $V_{DD} = 3.3V$ ,  $T_A = 25^\circ C$  for Typ, and are not production tested.  $I_{DD} (f=0) = 120mA$  (Typ).
- $\overline{CE}_X = V_{IL}$  means  $\overline{CE}_{0X} = V_{IL}$  and  $CE_{1X} = V_{IH}$   
 $\overline{CE}_X = V_{IH}$  means  $\overline{CE}_{0X} = V_{IH}$  or  $CE_{1X} = V_{IL}$   
 $\overline{CE}_X \leq 0.2V$  means  $\overline{CE}_{0X} \leq 0.2V$  and  $CE_{1X} \geq V_{DDQ} - 0.2V$   
 $\overline{CE}_X \geq V_{DDQ} - 0.2V$  means  $\overline{CE}_{0X} \geq V_{DDQ} - 0.2V$  or  $CE_{1X} \leq 0.2V$   
 "X" represents "L" for left port or "R" for right port.

### AC Test Conditions

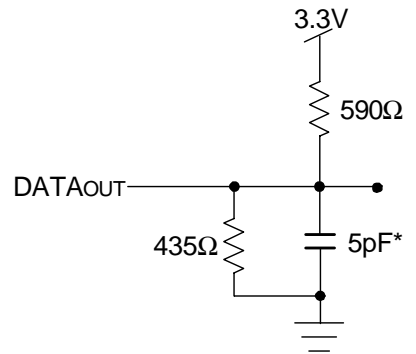
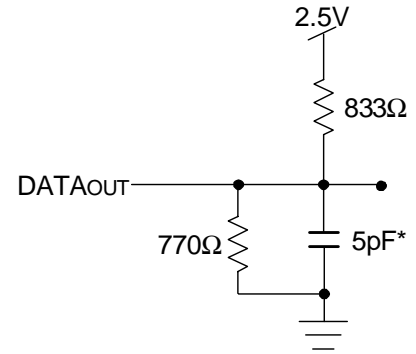
Input Pulse Levels (Address & Controls)	GND to 3.0V/GND to 2.35V
Input Pulse Levels (I/Os)	GND to 3.0V/GND to 2.35V
Input Rise/Fall Times	3ns
Input Timing Reference Levels	1.5V/1.25V
Output Reference Levels	1.5V/1.25V
Output Load	Figures 1, 2, and 3

4831 tbl 10



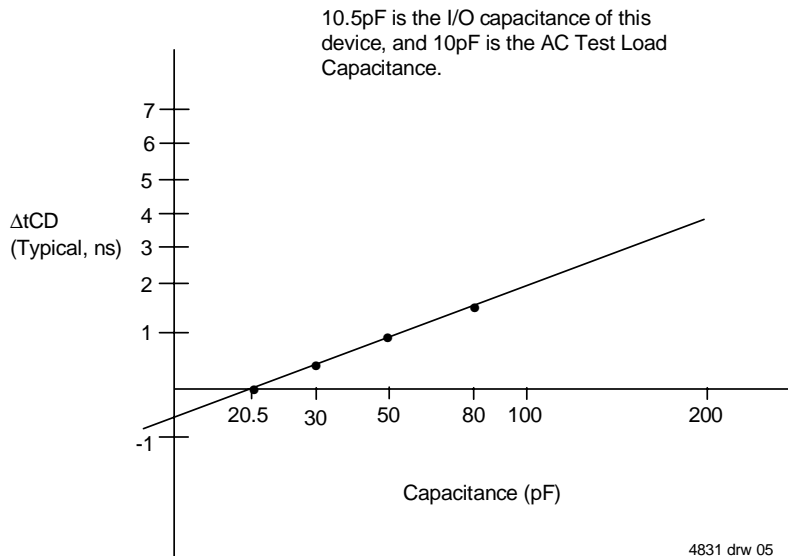
4831 drw 03

Figure 1. AC Output Test load.



4831 drw 04

Figure 2. Output Test Load  
(For t<sub>CKLZ</sub>, t<sub>CKHZ</sub>, t<sub>OLZ</sub>, and t<sub>OHZ</sub>).  
\*Including scope and jig.



4831 drw 05

Figure 3. Typical Output Derating (Lumped Capacitive Load).

## AC Electrical Characteristics Over the Operating Temperature Range (Read and Write Cycle Timing)<sup>(1,2)</sup>

(V<sub>DD</sub> = 3.3V ± 150mV, T<sub>A</sub> = 0°C to +70°C)

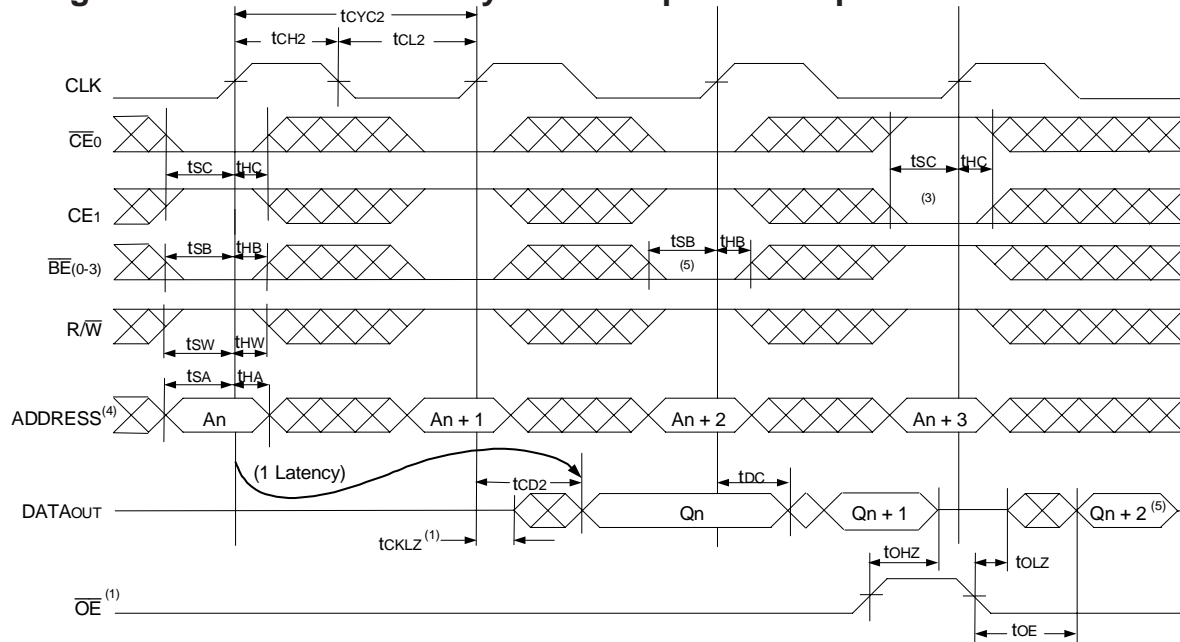
Symbol	Parameter	70V3569S4 Com'I Only		70V3569S5 Com'I & Ind		70V3569S6 Com'I Only		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>CYC2</sub>	Clock Cycle Time (Pipelined)	7.5	—	10	—	12	—	ns
t <sub>CH2</sub>	Clock High Time (Pipelined)	3	—	4	—	5	—	ns
t <sub>CL2</sub>	Clock Low Time (Pipelined)	3	—	4	—	5	—	ns
t <sub>R</sub>	Clock Rise Time	—	3	—	3	—	3	ns
t <sub>F</sub>	Clock Fall Time	—	3	—	3	—	3	ns
t <sub>SA</sub>	Address Setup Time	1.8	—	2.0	—	2.0	—	ns
t <sub>HA</sub>	Address Hold Time	0.7	—	0.7	—	1.0	—	ns
t <sub>SC</sub>	Chip Enable Setup Time	1.8	—	2.0	—	2.0	—	ns
t <sub>HC</sub>	Chip Enable Hold Time	0.7	—	0.7	—	1.0	—	ns
t <sub>SB</sub>	Byte Enable Setup Time	1.8	—	2.0	—	2.0	—	ns
t <sub>HB</sub>	Byte Enable Hold Time	0.7	—	0.7	—	1.0	—	ns
t <sub>SW</sub>	R/W Setup Time	1.8	—	2.0	—	2.0	—	ns
t <sub>HW</sub>	R/W Hold Time	0.7	—	0.7	—	1.0	—	ns
t <sub>SD</sub>	Input Data Setup Time	1.8	—	2.0	—	2.0	—	ns
t <sub>HD</sub>	Input Data Hold Time	0.7	—	0.7	—	1.0	—	ns
t <sub>SAD</sub>	$\overline{ADS}$ Setup Time	1.8	—	2.0	—	2.0	—	ns
t <sub>HAD</sub>	$\overline{ADS}$ Hold Time	0.7	—	0.7	—	1.0	—	ns
t <sub>SCN</sub>	$\overline{CNTEN}$ Setup Time	1.8	—	2.0	—	2.0	—	ns
t <sub>HCN</sub>	$\overline{CNTEN}$ Hold Time	0.7	—	0.7	—	1.0	—	ns
t <sub>SRST</sub>	$\overline{CNTRST}$ Setup Time	1.8	—	2.0	—	2.0	—	ns
t <sub>HRST</sub>	$\overline{CNTRST}$ Hold Time	0.7	—	0.7	—	1.0	—	ns
t <sub>OE<sup>(1)</sup></sub>	Output Enable to Data Valid	—	4	—	5	—	6	ns
t <sub>OLZ</sub>	Output Enable to Output Low-Z	0	—	0	—	0	—	ns
t <sub>OHZ</sub>	Output Enable to Output High-Z	1	4	1	4.5	1	5	ns
t <sub>CD2</sub>	Clock to Data Valid (Pipelined)	—	4.2	—	5	—	6	ns
t <sub>DC</sub>	Data Output Hold After Clock High	1	—	1	—	1	—	ns
t <sub>CKHZ</sub>	Clock High to Output High-Z	1	3	1	4.5	1.5	6	ns
t <sub>CKLZ</sub>	Clock High to Output Low-Z	1	—	1	—	1	—	ns
<b>Port-to-Port Delay</b>								
t <sub>CO</sub>	Clock-to-Clock Offset	6	—	8	—	10	—	ns

4831 tbl 11

**NOTES:**

1. All input signals are synchronous with respect to the clock except for the asynchronous Output Enable ( $\overline{OE}$ ).
2. These values are valid for either level of V<sub>DD0</sub> (3.3V/2.5V). See page 4 for details on selecting the desired I/O voltage levels for each port.

## Timing Waveform of Read Cycle for Pipelined Operation<sup>(2)</sup>

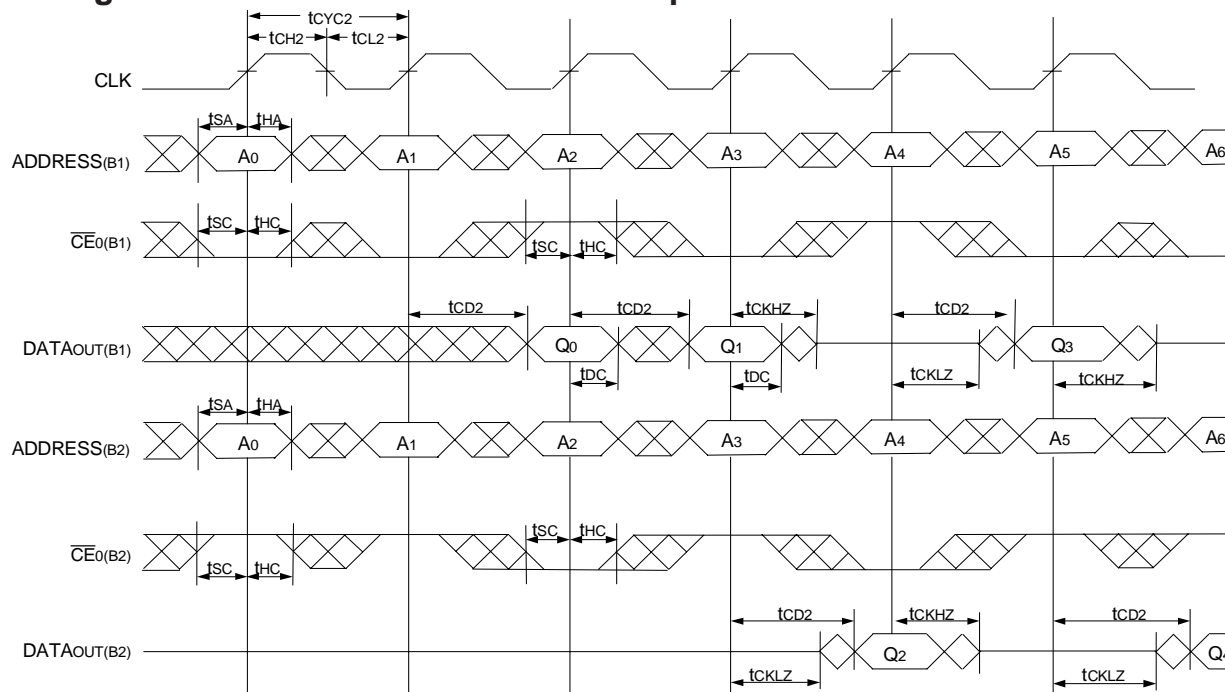


**NOTES:**

1.  $\overline{OE}$  is asynchronously controlled; all other inputs are synchronous to the rising clock edge.
2.  $\overline{ADS} = V_{IL}$ ,  $\overline{CNTEN}$  and  $\overline{CNRST} = V_{IH}$ .
3. The output is disabled (High-Impedance state) by  $\overline{CE}_0 = V_{IH}$ ,  $CE_1 = V_{IL}$ ,  $\overline{BE}_n = V_{IH}$  following the next rising edge of the clock. Refer to Truth Table 1.
4. Addresses do not have to be accessed sequentially since  $\overline{ADS} = V_{IL}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
5. If  $\overline{BE}_n$  was HIGH, then the appropriate Byte of DATAout for  $Q_n + 2$  would be disabled (High-Impedance state).

4831 drw 06

## Timing Waveform of a Multi-Device Pipelined Read<sup>(1,2)</sup>

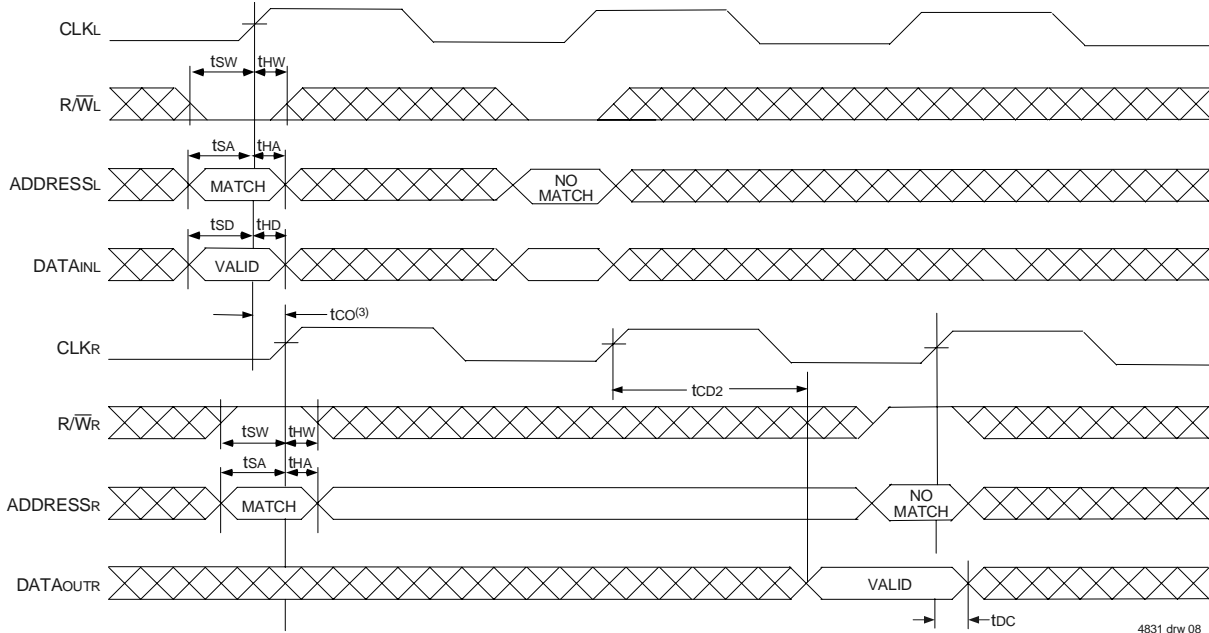


**NOTES:**

1. B1 Represents Device #1; B2 Represents Device #2. Each Device consists of one IDT70V3569 for this waveform, and are setup for depth expansion in this example.  $ADDRESS_{(B1)} = ADDRESS_{(B2)}$  in this situation.
2.  $\overline{BE}_n$ ,  $\overline{OE}$ , and  $\overline{ADS} = V_{IL}$ ;  $CE_1(B2)$ ,  $R/\overline{W}$ ,  $\overline{CNTEN}$ , and  $\overline{CNRST} = V_{IH}$ .

4831 drw 07

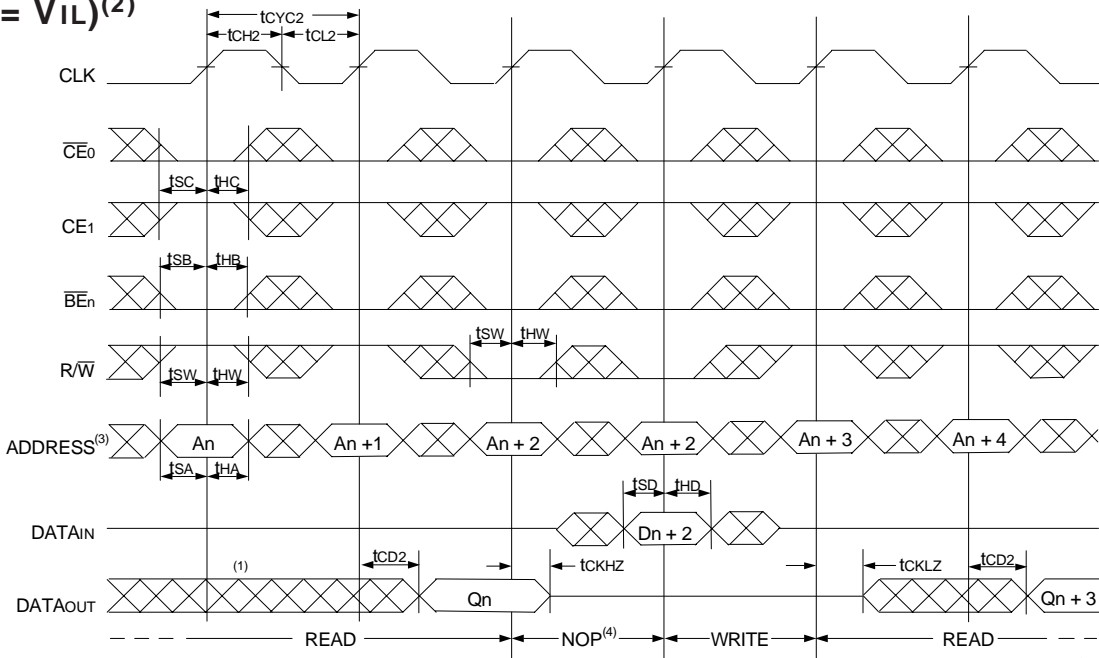
### Timing Waveform of Left Port Write to Pipelined Right Port Read<sup>(1,2)</sup>



**NOTES:**

1.  $\overline{CE}_0$ ,  $\overline{BE}_n$ , and  $\overline{ADS} = V_{IL}$ ;  $CE_1$ ,  $\overline{CNTEN}$ , and  $\overline{CNTRST} = V_{IH}$ .
2.  $\overline{OE} = V_{IL}$  for the Right Port, which is being read from.  $\overline{OE} = V_{IH}$  for the Left Port, which is being written to.
3. If  $t_{CO} \leq$  minimum specified, then data from right port read is not valid until following right port clock cycle (ie, time from write to valid read on opposite port will be  $t_{CO} + 2 t_{CYC2} + t_{CD2}$ ). If  $t_{CO} >$  minimum, then data from right port read is available on first right port clock cycle (ie, time from write to valid read on opposite port will be  $t_{CO} + t_{CYC} + t_{CD2}$ ).

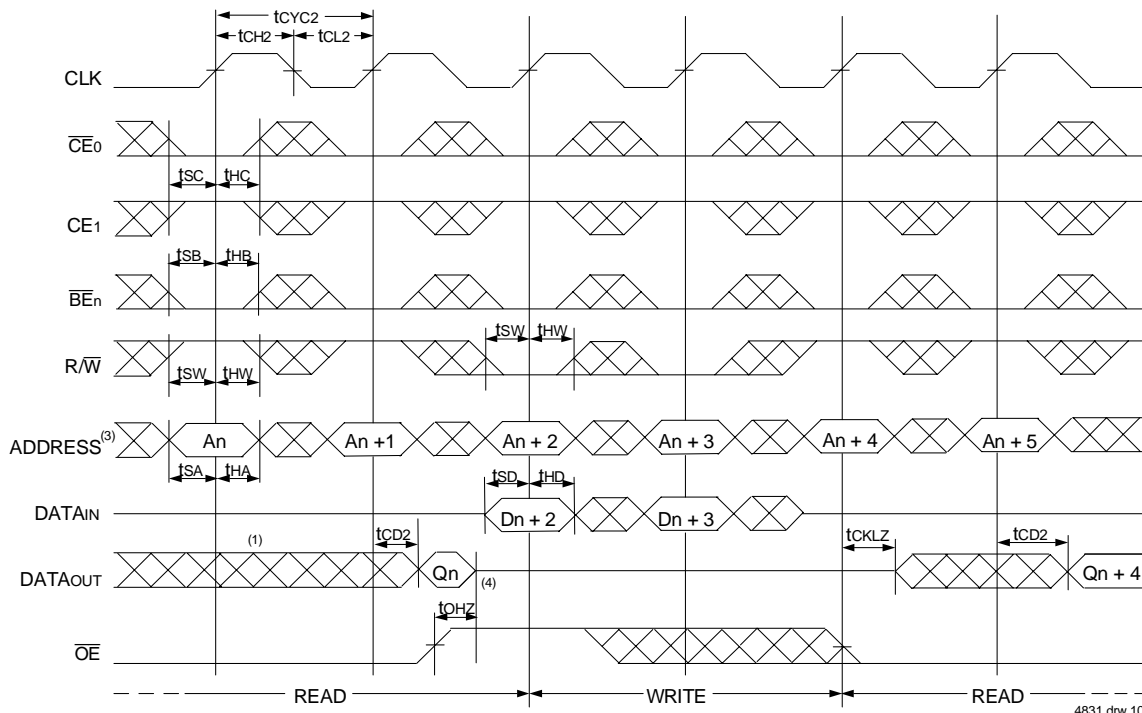
### Timing Waveform of Pipelined Read-to-Write-to-Read ( $\overline{OE} = V_{IL}$ )<sup>(2)</sup>



**NOTES:**

1. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
2.  $\overline{CE}_0$ ,  $\overline{BE}_n$ , and  $\overline{ADS} = V_{IL}$ ;  $CE_1$ ,  $\overline{CNTEN}$ , and  $\overline{CNTRST} = V_{IH}$ . "NOP" is "No Operation".
3. Addresses do not have to be accessed sequentially since  $\overline{ADS} = V_{IL}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
4. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

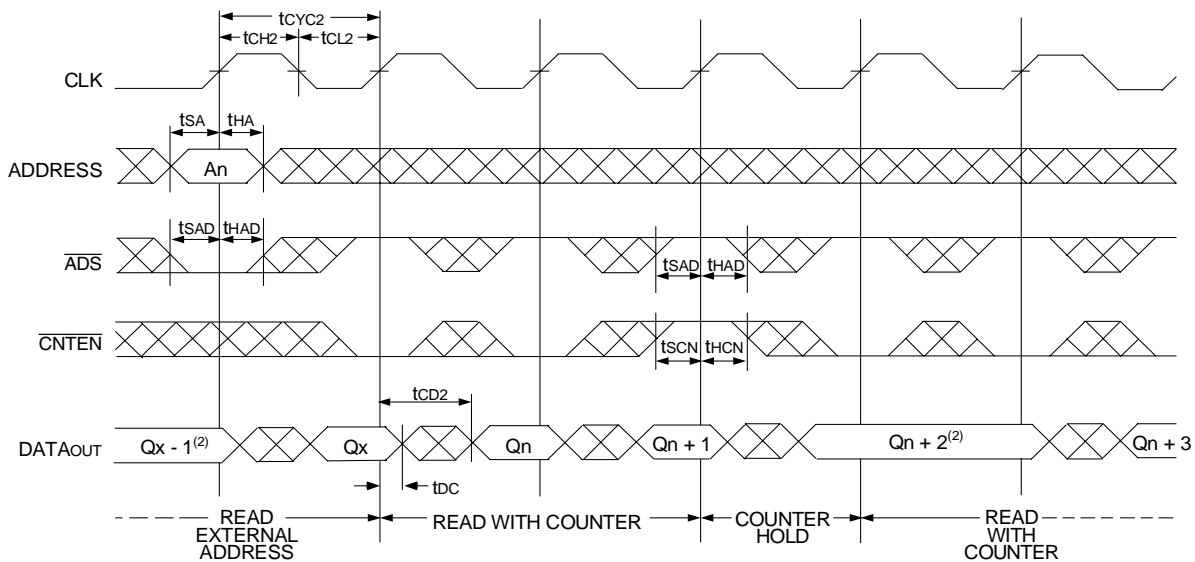
## Timing Waveform of Pipelined Read-to-Write-to-Read ( $\overline{OE}$ Controlled)<sup>(2)</sup>



**NOTES:**

1. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
2.  $\overline{CE}_0$ ,  $\overline{BE}_n$ , and  $\overline{ADS} = V_{IL}$ ;  $\overline{CE}_1$ ,  $\overline{CNTEN}$ , and  $\overline{CNTRST} = V_{IH}$ .
3. Addresses do not have to be accessed sequentially since  $\overline{ADS} = V_{IL}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
4. This timing does not meet requirements for fastest speed grade. This waveform indicates how logically it could be done if timing so allows.

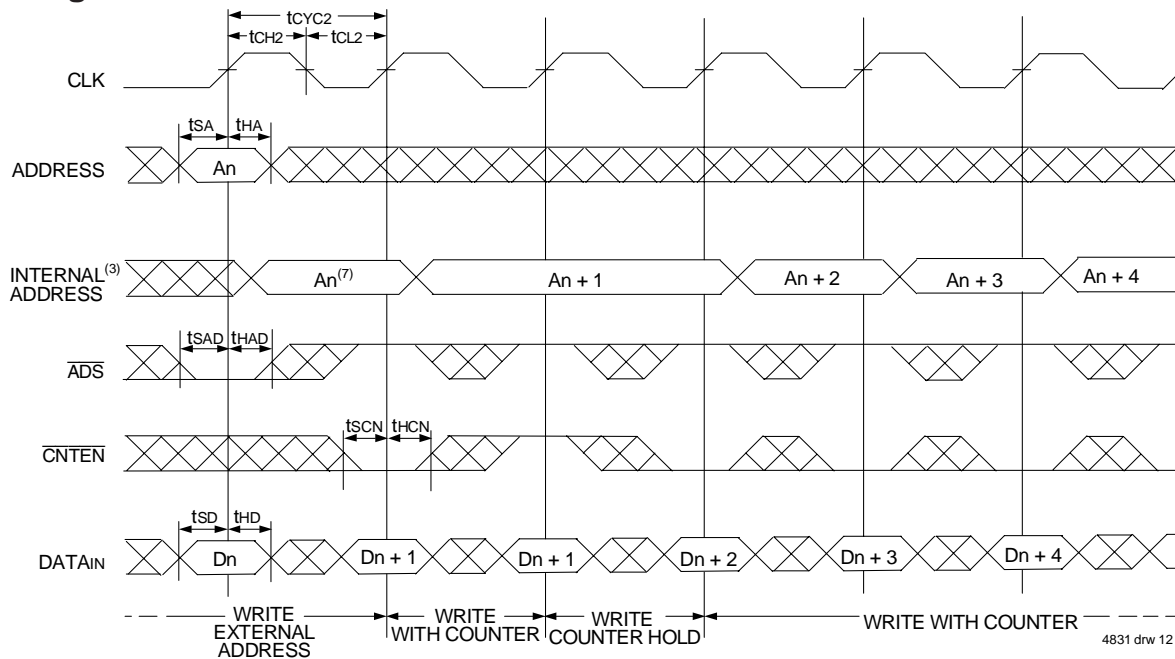
## Timing Waveform of Pipelined Read with Address Counter Advance<sup>(1)</sup>



**NOTES:**

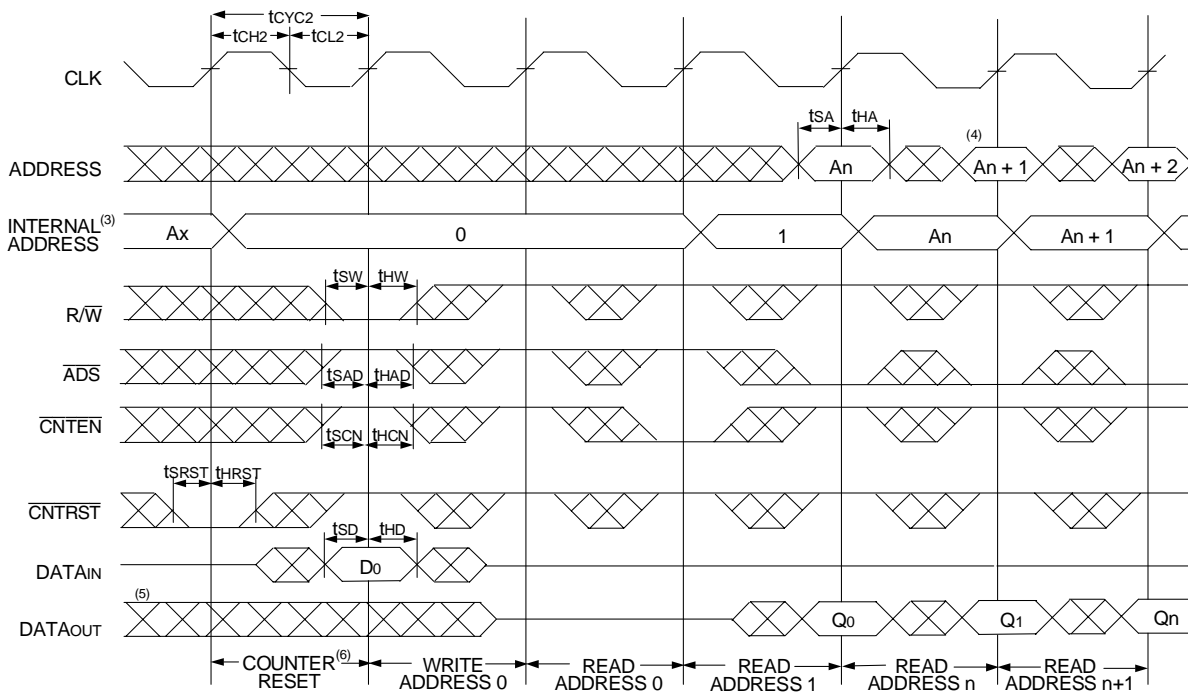
1.  $\overline{CE}_0$ ,  $\overline{OE}$ ,  $\overline{BE}_n = V_{IL}$ ;  $\overline{CE}_1$ ,  $\overline{R/W}$ , and  $\overline{CNTRST} = V_{IH}$ .
2. If there is no address change via  $\overline{ADS} = V_{IL}$  (loading a new address) or  $\overline{CNTEN} = V_{IL}$  (advancing the address), i.e.  $\overline{ADS} = V_{IH}$  and  $\overline{CNTEN} = V_{IH}$ , then the data output remains constant for subsequent clocks.

### Timing Waveform of Write with Address Counter Advance<sup>(1)</sup>



4831 drw 12

### Timing Waveform of Counter Reset<sup>(2)</sup>



4831 drw 13

**NOTES:**

1.  $\overline{CE}_0$ ,  $\overline{BE}_n$ , and  $R/\overline{W} = V_{IL}$ ;  $CE_1$  and  $\overline{CNTRST} = V_{IH}$ .
2.  $\overline{CE}_0$ ,  $\overline{BE}_n = V_{IL}$ ;  $CE_1 = V_{IH}$ .
3. The "Internal Address" is equal to the "External Address" when  $\overline{ADS} = V_{IL}$  and equals the counter output when  $\overline{ADS} = V_{IH}$ .
4. Addresses do not have to be accessed sequentially since  $\overline{ADS} = V_{IL}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
5. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
6. No dead cycle exists during counter reset. A READ or WRITE cycle may be coincidental with the counter reset cycle: Addr 0 will be accessed. Extra cycles are shown here simply for clarification.
7.  $CNTEN = V_{IL}$  advances Internal Address from 'An' to 'An +1'. The transition shown indicates the time required for the counter to advance. The 'An +1' Address is written to during this cycle.

## Functional Description

The IDT70V3569 provides a true synchronous Dual-Port Static RAM interface. Registered inputs provide minimal set-up and hold times on address, data, and all critical control inputs. All internal registers are clocked on the rising edge of the clock signal, however, the self-timed internal write pulse is independent of the LOW to HIGH transition of the clock signal.

An asynchronous output enable is provided to ease asynchronous bus interfacing. Counter enable inputs are also provided to stall the operation of the address counters for fast interleaved memory applications.

A HIGH on  $\overline{CE_0}$  or a LOW on  $CE_1$  for one clock cycle will power down the internal circuitry to reduce static power consumption. Multiple chip enables allow easier banking of multiple IDT70V3569s for depth expansion configurations. Two cycles are required with  $\overline{CE_0}$  LOW and  $CE_1$  HIGH to re-activate the outputs.

## Depth and Width Expansion

The IDT70V3569 features dual chip enables (refer to Truth Table I) in order to facilitate rapid and simple depth expansion with no requirements for external logic. Figure 4 illustrates how to control the various chip enables in order to expand two devices in depth.

The IDT70V3569 can also be used in applications requiring expanded width, as indicated in Figure 4. Through combining the control signals, the devices can be grouped as necessary to accommodate applications needing 72-bits or wider.

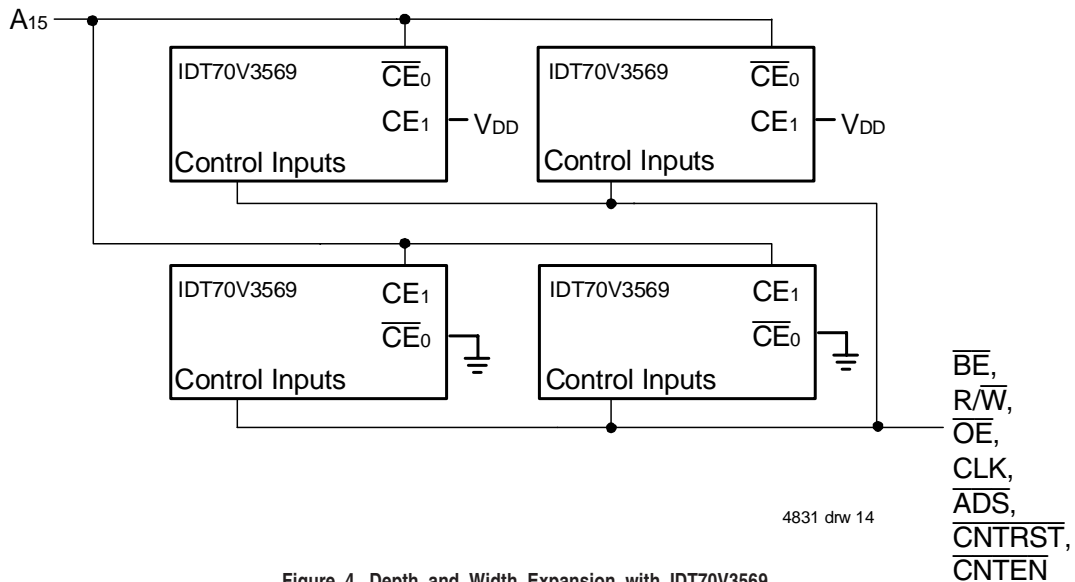
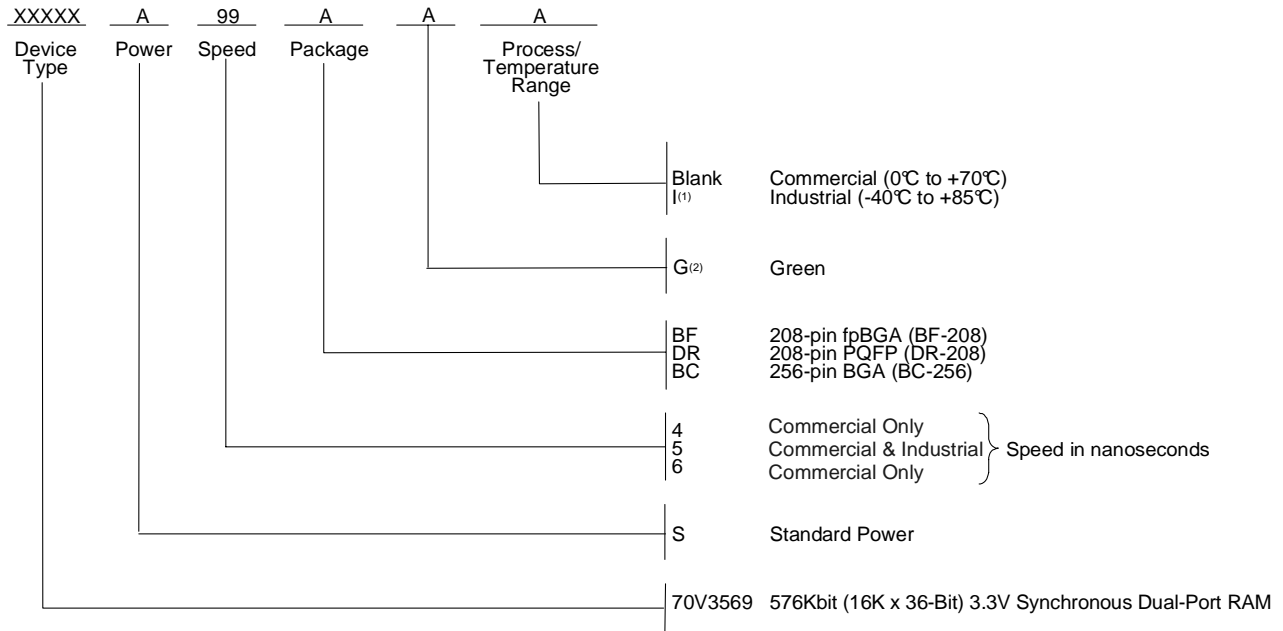


Figure 4. Depth and Width Expansion with IDT70V3569

## Ordering Information



4831 drw 15

### NOTES:

1. Contact your local sales office for Industrial temp range in other speeds, packages and powers.
2. Green parts available. For specific speeds, packages and powers contact your local sales office.

## Datasheet Document History

- 1/8/99: Initial Public Release
  - 3/12/99: Added fpBGA package
  - 4/28/99: Fixed typo on page 10
  - 6/8/99: Changed drawing format
    - Page 2 Changed package body dimensions
    - Page 3 Fixed typo
  - 6/15/99: Page 5 Deleted note 6 for Table II
  - 8/4/99: Page 2 Fixed typographical error
    - Page 6 Improved power number
  - 10/14/99: Upgraded speed to 133MHz, added 2.5V I/O capability
  - 10/19/99: Page 4 Corrected I/O numbers in Truth Table I
  - 11/12/99: Replaced IDT logo
  - 4/10/00: Added new BGA packages, added full 2.5V interface capability
- Continued on page 17**

## Datasheet Document History (cont'd)

- 01/12/01: Page 6 Updated Truth Table II  
Increased storage temperature parameter  
Clarified TA Parameter  
Page 8 DC Electrical parameters—changed wording from "open" to "disabled"  
Removed note 7 on DC Electrical Characteristics table  
Removed Preliminary status
- 04/10/01: Added Industrial Temperature Ranges and removed related notes
- 12/12/01: Page 2, 3 & 4 Added date revision to pin configurations  
Page 6 Removed industrial temp footnote from table 04  
Page 8 & 10 Removed industrial temp for 6ns from DC & AC Electrical Characteristics  
Page 16 Removed industrial temp from 6ns in ordering information  
Added industrial temp footnote  
Page 1 & 17 Replaced  $\text{TM}$  logo with  $\text{®}$  logo
- 3/23/05: Page 1 Added green availability to features  
Page 16 Added green indicator to ordering information  
Page 1 & 17 Replaced old IDT  $\text{TM}$  with new IDT  $\text{TM}$  logo
- 02/08/06: Page 5 Changed footnote 2 for Truth Table I from  $\overline{\text{ADS}}, \overline{\text{CNTEN}}, \overline{\text{CNTRST}} = V_{\text{IH}}$  to  $\overline{\text{ADS}}, \overline{\text{CNTEN}}, \overline{\text{CNTRST}} = X$
- 07/25/08: Page 8 Corrected a typo in the DC Chars table
- 10/23/08: Page 16 Removed "IDT" from orderable part number



**CORPORATE HEADQUARTERS**  
6024 Silver Creek Valley Road  
San Jose, CA 95138

**for SALES:**  
800-345-7015 or 408-284-8200  
fax: 408-284-2775  
www.idt.com

**for Tech Support:**  
408-284-2794  
DualPortHelp@idt.com

The IDT logo is a registered trademark of Integrated Device Technology, Inc.